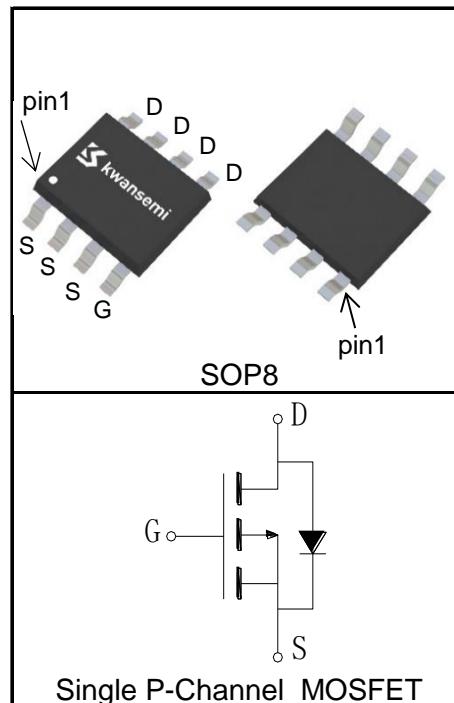


Features

- -40V/-9A,
 $R_{DS(ON)} = 15m\Omega$ (Typ.)@ $V_{GS}=-10V$
- $R_{DS(ON)} = 20m\Omega$ (Typ.)@ $V_{GS}=-4.5V$
- Low $R_{DS(ON)}$
- Super High Dense Cell Design
- Reliable and Rugged

Pin Description



Applications

- Load Switch
- DC-DC Converter
- Power Management



Halogen-Free

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
Common Ratings ($T_A=25^\circ C$ Unless Otherwise Noted)			
V_{DSS}	Drain-Source Voltage	-40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_{Jmax}	Maximum Junction Temperature	150	$^\circ C$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ C$
I_S	Diode Continuous Forward Current	$T_A=25^\circ C$	-2.9
			A

Mounted on Large Heat Sink

$I_{DP}^{①}$	Pulse Drain Current	$T_A=25^\circ C$	-36	A
$I_D^{②}$	Continuous Drain Current($V_{GS}=-10V$)	$T_A=25^\circ C$	-9	A
		$T_A=70^\circ C$	-7.2	
P_D	Maximum Power Dissipation	$T_A=25^\circ C$	2.5	W
		$T_A=70^\circ C$	1.6	
$R_{\theta JL}$	Thermal Resistance-Junction to Lead		25	$^\circ C/W$
$R_{\theta JA}^{③}$	Thermal Resistance-Junction to Ambient		50	$^\circ C/W$

Drain-Source Avalanche Ratings

$E_{AS}^{④}$	Avalanche Energy, Single Pulsed	196	mJ
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Electrical Characteristics ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

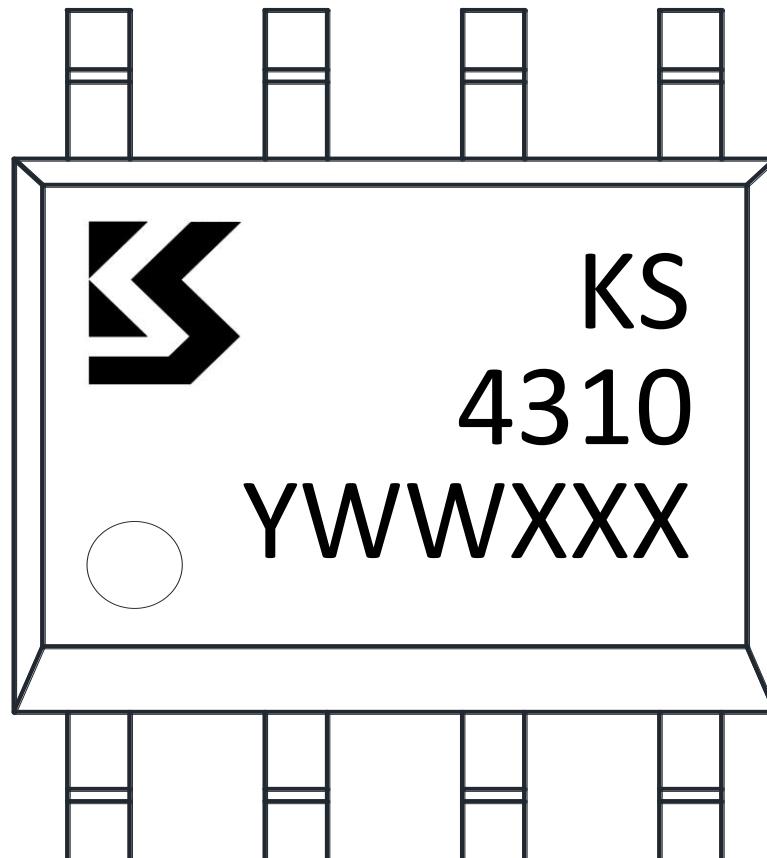
Symbol	Parameter	Test Condition	KS4310HA			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=-250\mu\text{A}$	-40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=-40\text{V}, V_{\text{GS}}=0\text{V}$			-1	μA
		$T_J=125^\circ\text{C}$			-30	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=-250\mu\text{A}$	-1.1	-1.6	-2.3	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$			± 100	nA
$R_{\text{DS}(\text{ON})}^{(5)}$	Drain-Source On-state Resistance	$V_{\text{GS}}=-10\text{V}, I_{\text{DS}}=-8\text{A}$		15	20	m Ω
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{DS}}=-5\text{A}$		20	28	m Ω
Diode Characteristics						
$V_{\text{SD}}^{(5)}$	Diode Forward Voltage	$I_{\text{SD}}=-8\text{A}, V_{\text{GS}}=0\text{V}$		-0.85	-1.2	V
t_{rr}	Reverse Recovery Time	$I_{\text{SD}}=-8\text{A}, dI_{\text{SD}}/dt=-100\text{A}/\mu\text{s}$		47		ns
Q_{rr}	Reverse Recovery Charge			41		nC
Dynamic Characteristics ⁽⁶⁾						
R_G	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}, F=1\text{MHz}$		7.5		Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=-20\text{V}, \text{Frequency}=1.0\text{MHz}$		2950		pF
C_{oss}	Output Capacitance			205		
C_{rss}	Reverse Transfer Capacitance			180		
$t_{\text{d}(\text{ON})}$	Turn-on Delay Time	$V_{\text{DD}}=-20\text{V}, I_{\text{DS}}=-8\text{A}, V_{\text{GEN}}=-10\text{V}, R_G=6\Omega$		12		ns
t_r	Turn-on Rise Time			21		
$t_{\text{d}(\text{OFF})}$	Turn-off Delay Time			42		
t_f	Turn-off Fall Time			11		
Gate Charge Characteristics ⁽⁶⁾						
Q_g	Total Gate Charge	$V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=-10\text{V}, I_{\text{DS}}=-8\text{A}$		48		nC
Q_{gs}	Gate-Source Charge			6		
Q_{gd}	Gate-Drain Charge			12		

Notes:

- (1)Pulse width limited by safe operating area.
- (2)Calculated continuous current based on maximum allowable junction temperature.
- (3)When mounted on 1 inch square copper board, $t \leq 10\text{sec}$. The value in any given application depends on the user's specific board design.
- (4)Limited by $T_{J\max}$, Starting $T_J = 25^\circ\text{C}$, $I_{AS\max} = -28\text{A}$, $L = 0.5\text{mH}$, $V_{\text{DD}} = -20\text{V}$, $R_G = 25\Omega$, $V_{\text{GS}} = -10\text{V}$. Part not recommended for use above this value.
- (5)Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- (6)Guaranteed by design, not subject to production testing.

Ordering and Marking Information

Device	Package	Packaging	Quantity	Reel Size	Tape width
KS4310HA	SOP8	Tape&Reel	3000	13"	12mm

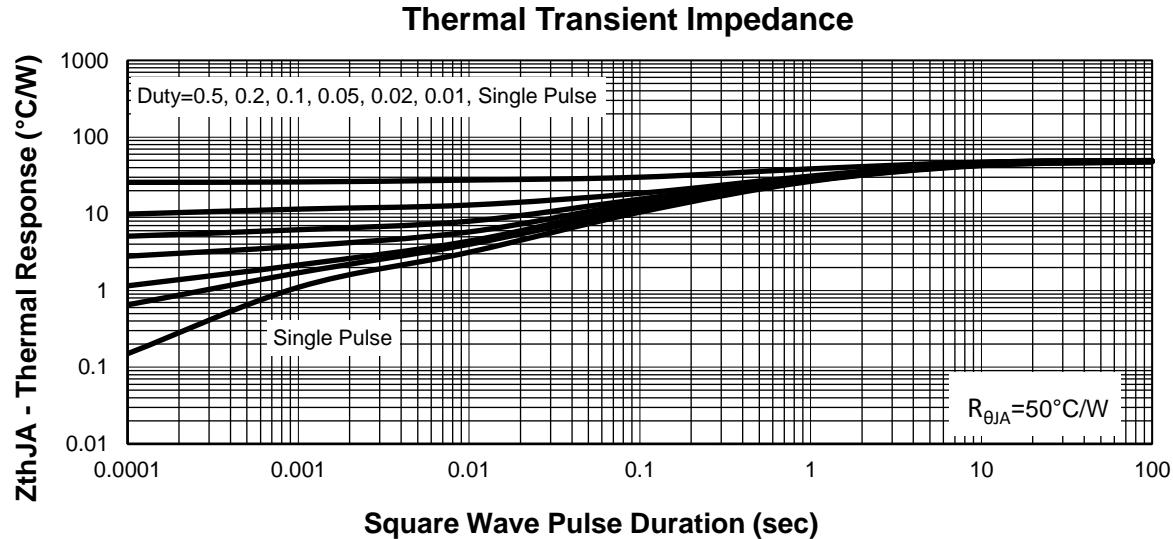
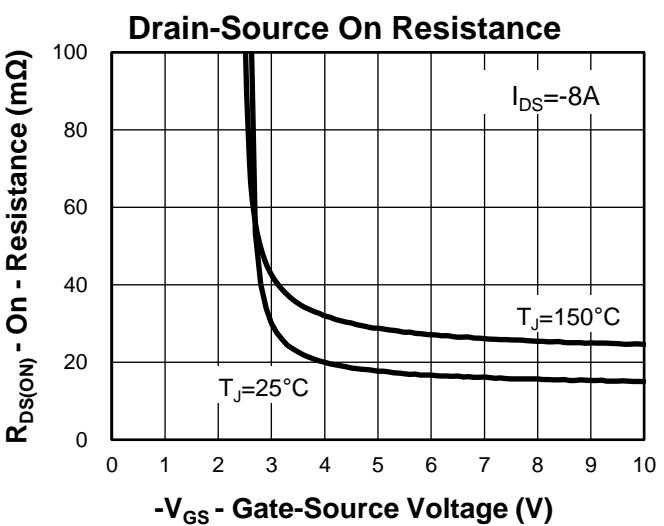
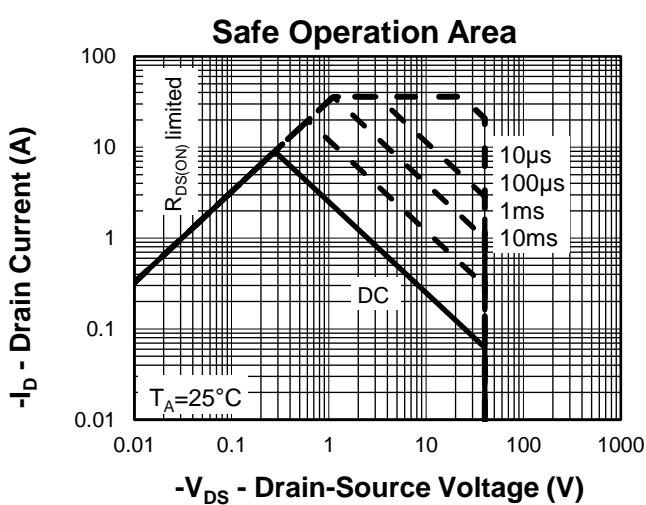
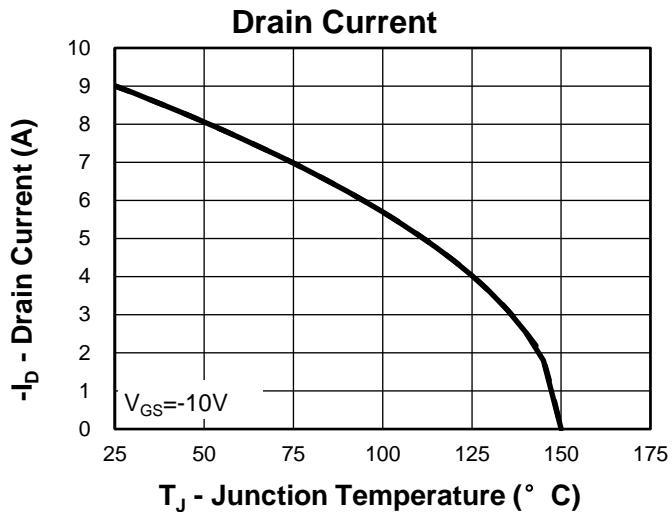
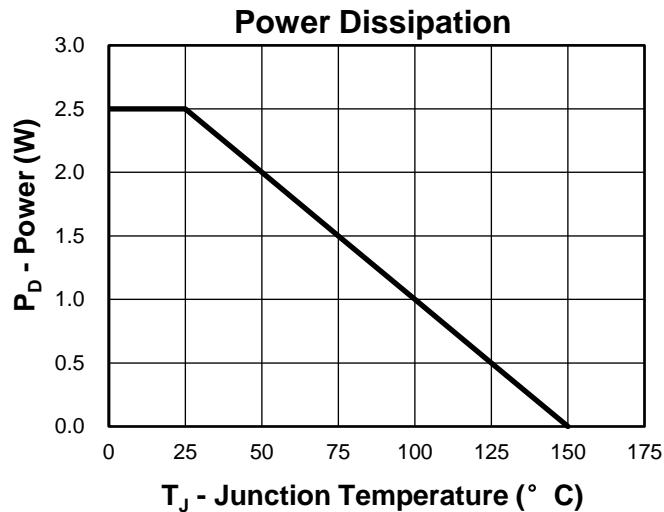


1st Line: Kwansemi LOGO, Kwansemi Code(KS)

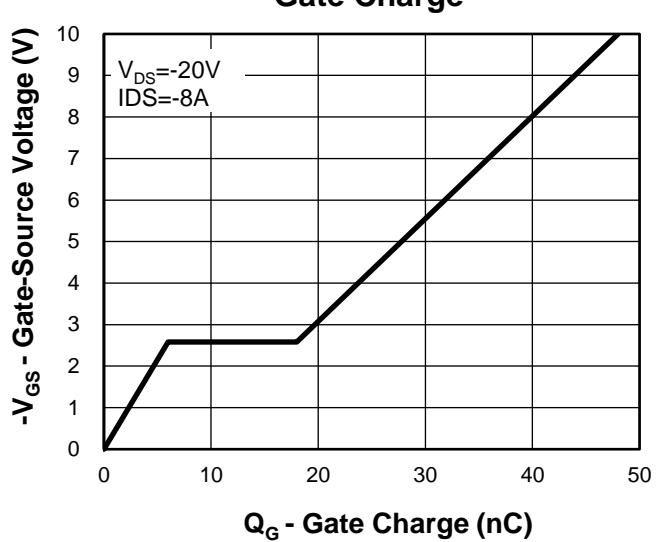
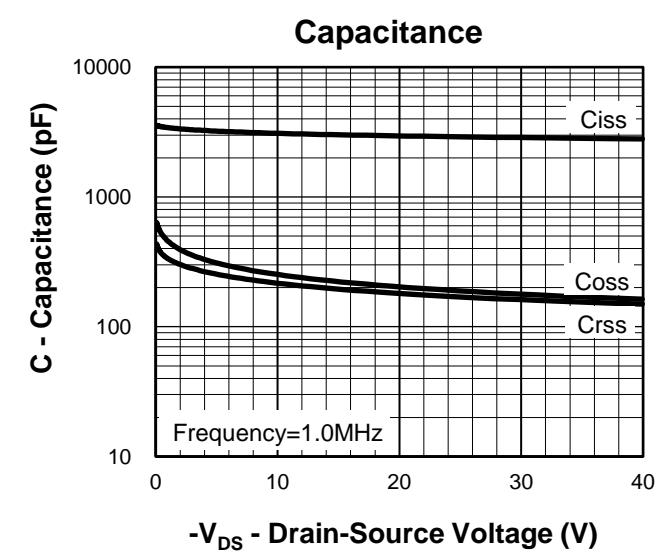
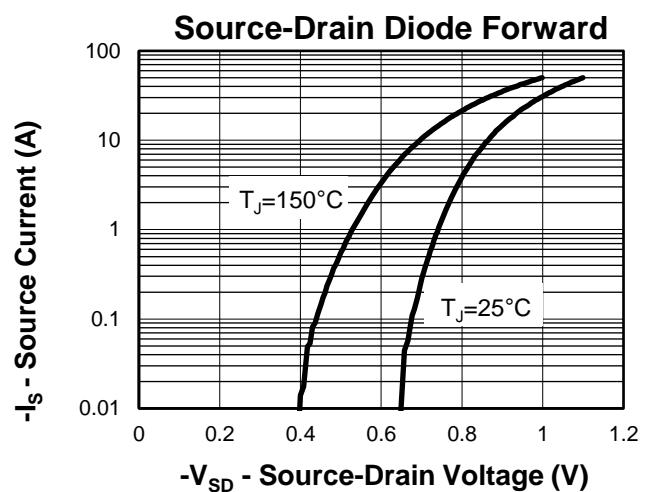
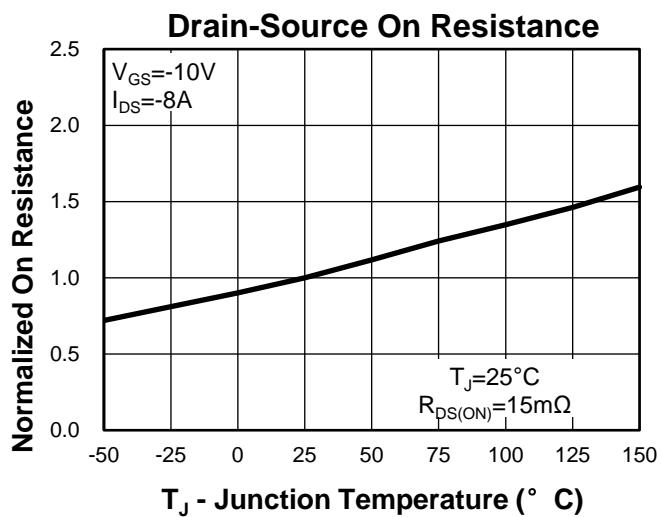
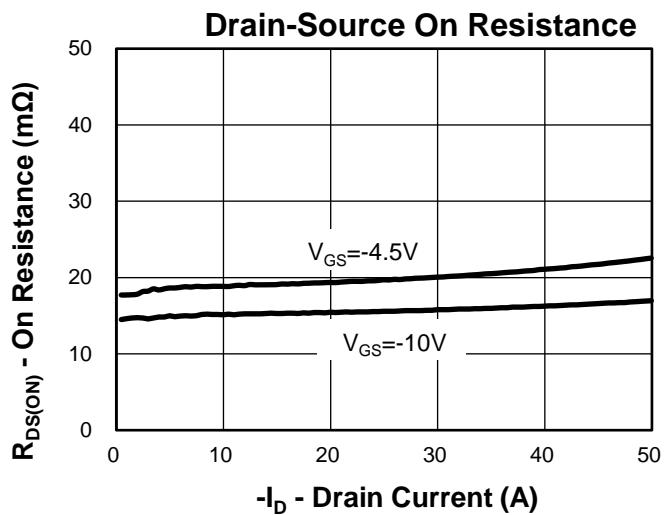
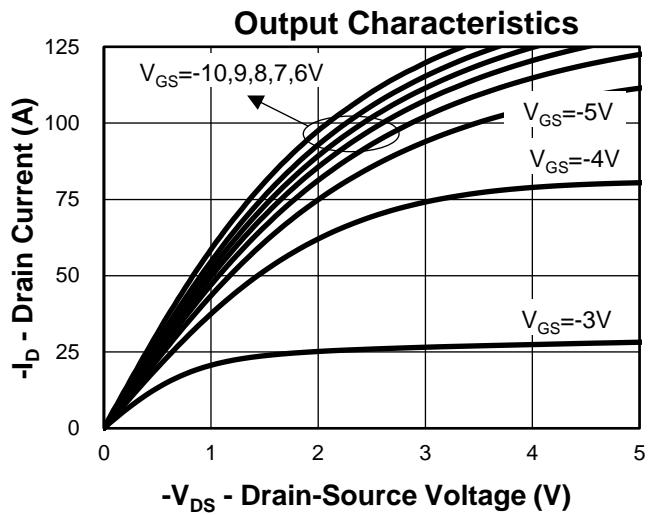
2nd Line: Part Number(4310)

3rd Line: Lot Number(YWWXXX)

Typical Characteristics

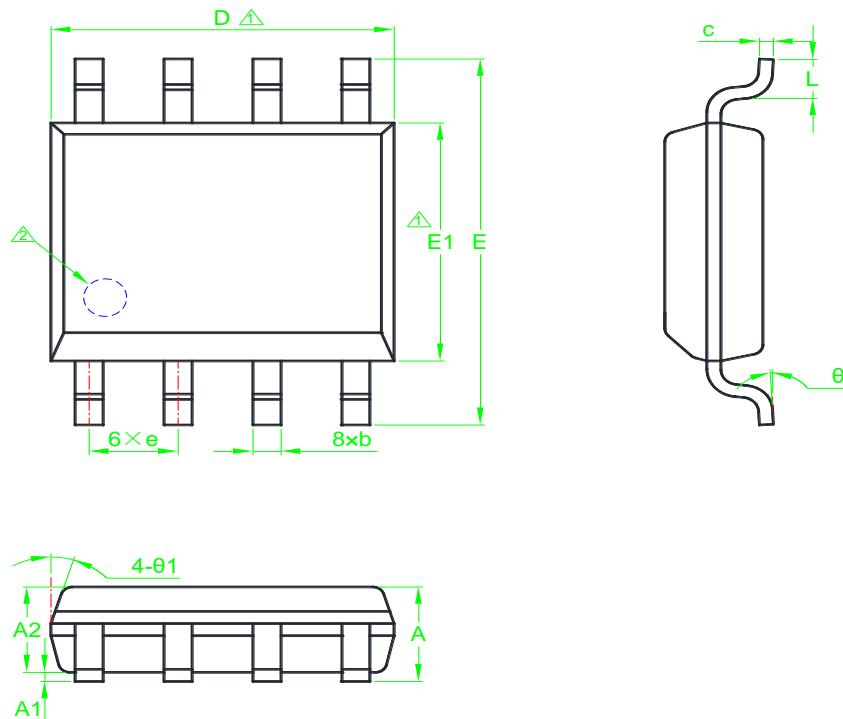


Typical Characteristics



Package Information

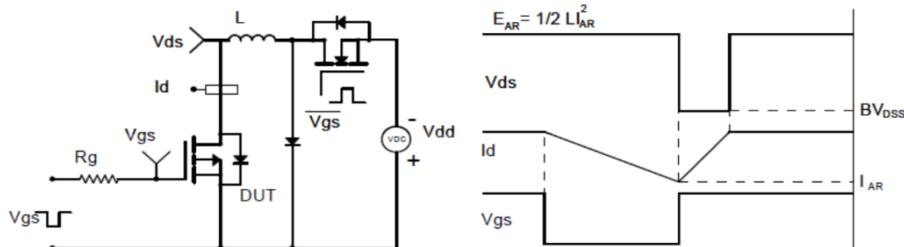
SOP8



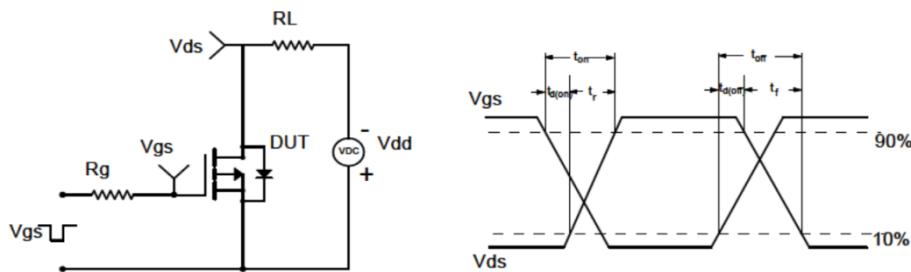
SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35	*	1.75	0.053	*	0.069
A1	0.10	*	0.25	0.004	*	0.010
A2	1.25	1.45	1.65	0.049	0.057	0.065
b	0.33	*	0.51	0.013	*	0.020
c	0.15	*	0.25	0.006	*	0.010
D	4.70	4.90	5.10	0.185	0.193	0.201
E	5.80	6.00	6.30	0.228	0.236	0.248
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	1.27BSC			0.050BSC		
L	0.40	*	1.27	0.016	*	0.050
θ	0°	*	8°	0°	*	8°
θ 1	5°	*	15°	5°	*	15°

- 1 Dimensions D and E1 do not include mold flash protrusions or gate burrs.
 2 The existence and size of demolding hole are variable depending on mold.

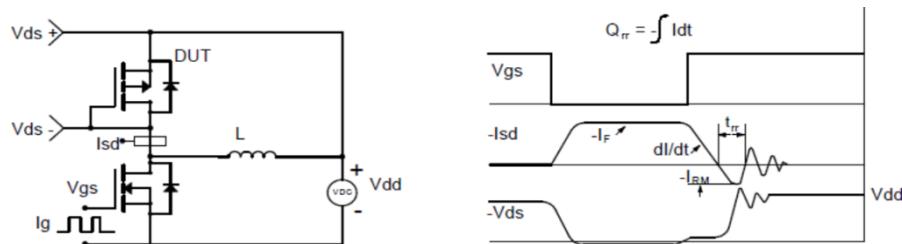
Avalanche Test Circuit and Waveforms



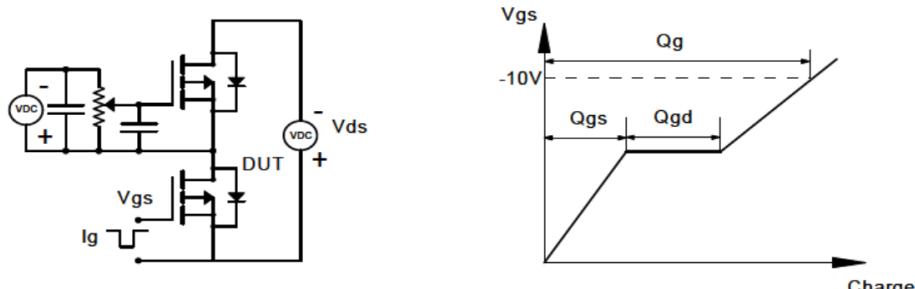
Switching Time Test Circuit and Waveforms



Diode Recovery Test Circuit and Waveforms



Gate Charge Test Circuit and Waveform



Customer Service

Kwansemi Semiconductor Co.,Ltd

Email:Sales@kwansemi.com

Web:www.kwansemi.com

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